TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ($L^2-\pi$ -MOSV)

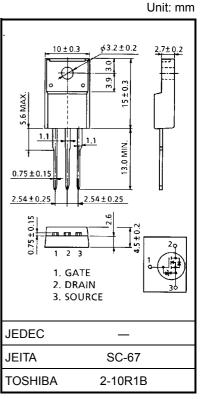
2SK2312

Chopper Regulator, DC–DC Converter and Motor Drive Applications

- 4 V gate drive
- Low drain-source ON resistance $: R_{DS} (ON) = 13 \text{ m}\Omega (typ.)$
- High forward transfer admittance $|Y_{fs}| = 40 \text{ S (typ.)}$
- Low leakage current $: I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 60 \ V)$
- Enhancement-mode : $V_{th} = 0.8 \sim 2.0 V (V_{DS} = 10 V, I_D = 1 mA)$

Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	60	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	60	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	۱ _D	45	А	
	Pulse (Note 1)	I _{DP}	180	А	
Drain power dissipatio	n (Tc = 25°C)	PD	45	W	
Single pulse avalanche energy (Note 2)		E _{AS}	701	mJ	
Avalanche current		I _{AR}	45	А	
Repetitive avalanche energy (Note 3)		E _{AR}	4.5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	



Weight: 1.9 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	2.78	°C / W
Thermal resistance, channel to ambient	R _{th (ch−a)}	62.5	°C / W

Note 1: Please use devices on condition that the channel temperature is below 150°C. Note 2: $V_{DD} = 25 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), $L = 471 \text{ }\mu\text{H}$, $R_G = 25 \Omega$, $I_{AR} = 45 \text{ A}$

Note 3: Repetitive rating; Pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device. Please handle with caution.

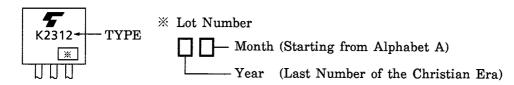
Electrical Characteristics (Ta = 25°C)

Charae	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V	_	—	±10	μA
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	100	μA
Drain-source bi	reakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	60	_	_	V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V
Drain-source ON resistance		R _{DS (ON)}	V _{GS} = 4 V, I _D = 25 A	_	19	25	- mΩ
			V _{GS} = 10 V, I _D = 25 A	_	13	17	
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 25 A	28	40		S
Input capacitant	ce	C _{iss}			3350		
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		550		pF
Output capacitance		C _{oss}		_	1600	_	
Switching time	Rise time	tr	$V_{GS} \stackrel{10V}{}_{0V} \int I_{D} = 25A$ $V_{OUT} \stackrel{V_{OUT}}{}_{RL} = 1.2\Omega$ $V_{DD} = 30V$ $Duty \leq 1\%, t_{w} = 10\mu s$	_	25	_	
	Turn-on time	t _{on}		_	55	_	- ns
	Fall time	t _f		_	60	_	
	Turn-off time	t _{off}		_	180	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	110	_	
Gate-source charge		Q _{gs}	V _{DD} ≈ 48 V, V _{GS} = 10 V, I _D = 45 A		70	_	nC
Gate-drain ("miller") charge		Q _{gd}			40	_	

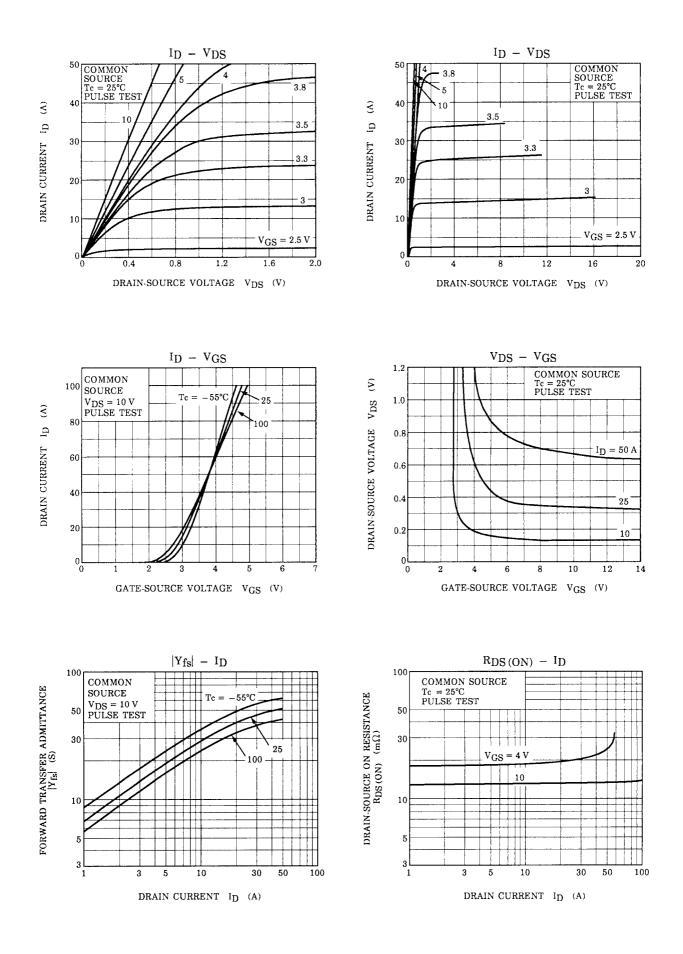
Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	_	45	А
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	180	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 45 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 45 A, V _{GS} = 0 V		120	—	ns
Reverse recovered charge	Q _{rr}	dl _{DR} / dt = 50 A / μs	_	0.2	_	μC

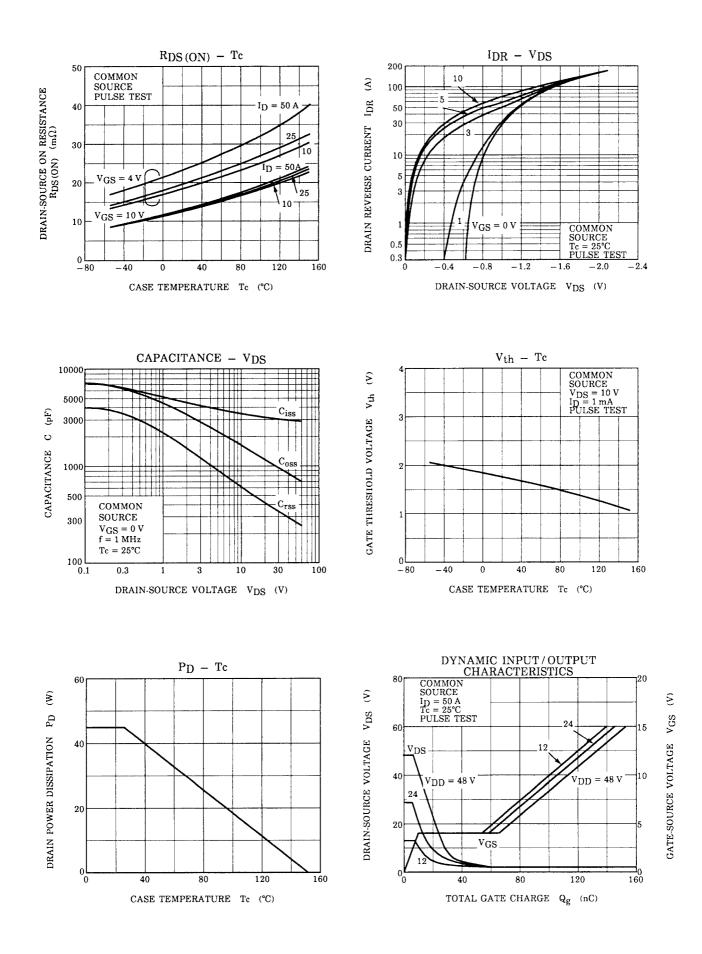
Marking

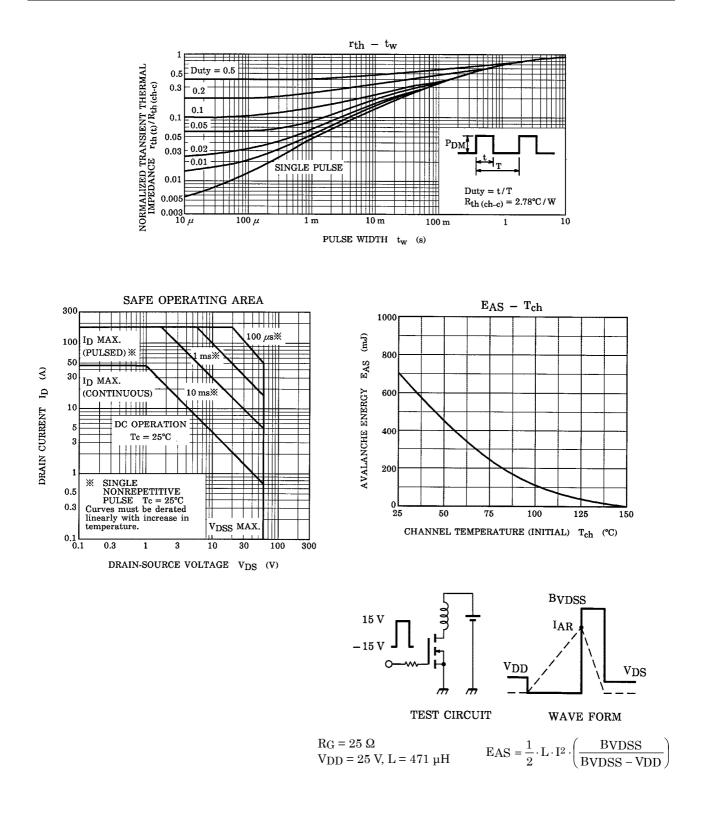


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